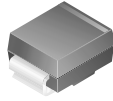


RoHS Compliant Product

A suffix of "-C" specifies halogen-free



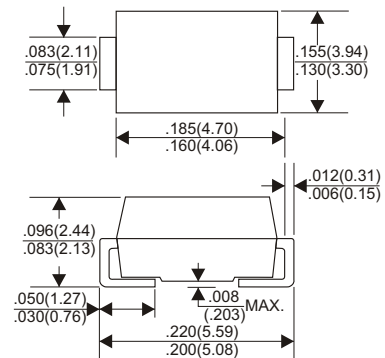
FEATURES

- * Ideal for surface mount applications
- * Easy pick and place
- * Built-in strain relief
- * Fast switching speed

MECHANICAL DATA

- * Case: Molded plastic
- * Epoxy: UL 94V-0 rate flame retardant
- * Metallurgically bonded construction
- * Polarity: Color band denotes cathode end
- * Mounting position: Any
- * Weight: 1.02 grams

DO-214AA(SMB)



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unless otherwise specified.
Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

TYPE NUMBER	SMF201B	SMF202B	SMF203B	SMF204B	SMF205B	SMF206B	SMF207B	UNITS	
Maximum Recurrent Peak Reverse Voltage	50	100	200	400	600	800	1000	V	
Maximum RMS Voltage	35	70	140	280	420	560	700	V	
Maximum DC Blocking Voltage	50	100	200	400	600	800	1000	V	
Maximum Average Forward Rectified Current									
.375"(9.5mm) Lead Length at Ta=55°C								2.0	A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)								50	A
Maximum Instantaneous Forward Voltage at 2.0A	1.3				1.5	1.7		V	
Maximum DC Reverse Current Ta=25°C								5.0	µA
at Rated DC Blocking Voltage Ta=100°C								100	µA
Maximum Reverse Recovery Time (Note 1)	150			250		500		nS	
Typical Junction Capacitance (Note 2)								15	pF
Thermal Resistance, Junction to Lead (Note 3)								18	
Thermal Resistance, Junction to Ambient (Note 3)								55	°C/W
Operating and Storage Temperature Range T _J , T _{STG}								-65 ~ +150	°C

NOTES:

1. Reverse Recovery Time test condition: IF=0.5A, IR=1.0A, IRR=0.25A
2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
3. Rating applies when surface mounted on the minimum pad size recommended, PC Board with 5.0X5.0mm Copper pad.

RATING AND CHARACTERISTIC CURVES (SMF201B THRU SMF207B)

FIG.1-TYPICAL FORWARD CHARACTERISTICS

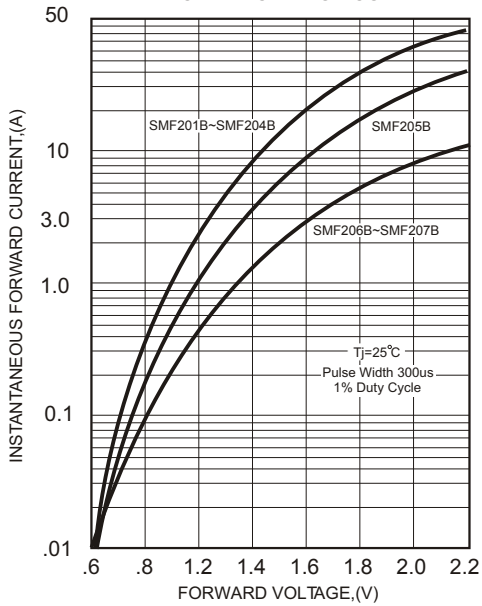


FIG.2-TYPICAL FORWARD CURRENT DERATING CURVE

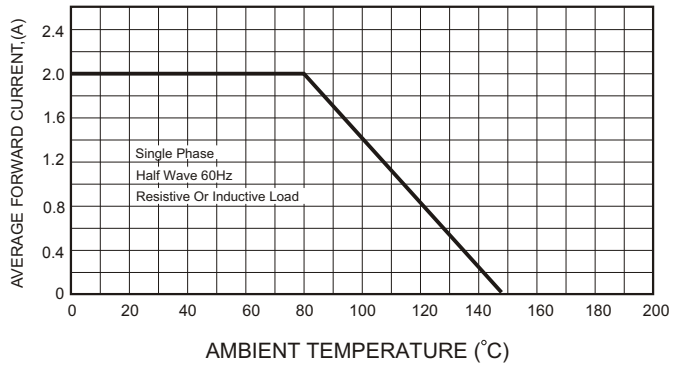
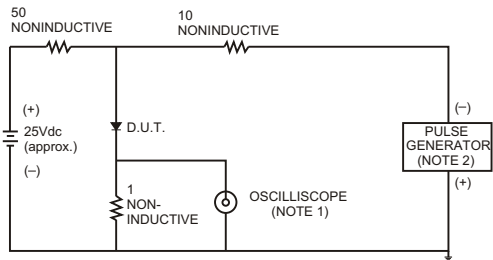


FIG.3- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm.22pF.
2. Rise Time= 10ns max., Source Impedance= 50 ohms.

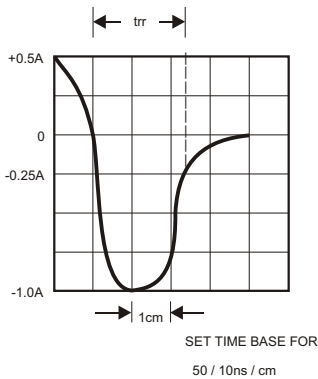


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

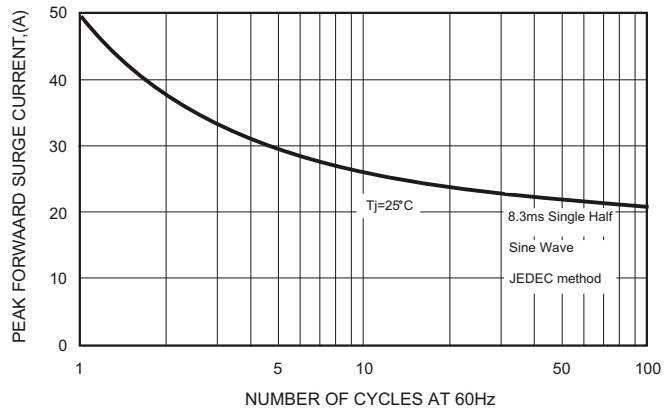


FIG.5-TYPICAL JUNCTION CAPACITANCE

